





COMPLEMENTARY 20V LOW SATURATION TRANSISTORS

Features

NPN Transistor

- BV_{CEO} > 20V
- I_C = 4.5A Continuous Collector Current
- Low Saturation Voltage (150mV max @ 1A)
- R_{SAT} = 47mΩ for a low equivalent On-Resistance

PNP Transistor

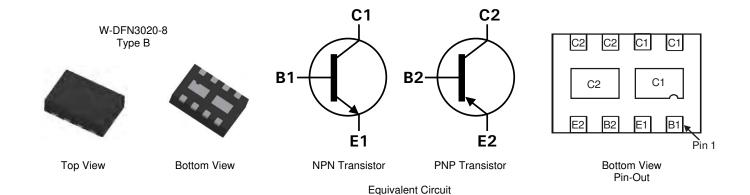
- BV_{CEO} > -20V
- I_C = -3.5A Continuous Collector Current
- Low Saturation Voltage (-220mV max @ -1A)
- R_{SAT} = 64mΩ for a low equivalent On-Resistance
- hFE characterized up to 6A for high current gain hold up
- Low profile 0.8mm high package for thin applications
- R_{0JA} efficient, 40% lower than SOT26
- 6mm² footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

- Case: W-DFN3020-8 Type B
- Nominal package height: 0.8mm
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.013 grams (approximate)

Applications

- DC DC Converters
- · Charging circuits
- Power switches
- Motor control
- LED Backlighting circuits
- Portable applications



Ordering Information (Note 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC6718MCTA	AEC-Q101	DB2	7	8	3,000
ZXTC6718MCQTA	Automotive	DB2	7	8	3,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.
- 5. For packaging details, go to our website at http://www.diodes.com

Marking Information



DB2 = Product type marking code Top view, dot denotes pin 1





Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	NPN	PNP	Unit		
Collector-Base Voltage	V _{CBO}	40	-25	V		
Collector-Emitter Voltage	V _{CEO}	20	-20	V		
Emitter-Base Voltage	V _{EBO}	7	-7	V		
Peak Pulse Current	Ісм	12	-6	Α		
Continuous Collector Current (Notes 6 & 9)		1	4.5	-3.5	۸	
Continuous Collector Current (Notes 7 & 9)		IC	5	-3.8	A	
Base Current	I _B		1	Α		

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	NPN	PNP	Unit	
	(Notes 6 & 9)		1.5 12 2.45 19.6 1.13 8		W mW/°C
Power Dissipation	(Notes 7 & 9)	5			
Linear Derating Factor	(Notes 8 & 9)	P_{D}			
	(Notes 8 & 10)		1.7 13.6		
	(Notes 6 & 9)		83.3 51.0 111 73.5		°C/W
Thermal Desistance Junation to Ambient	(Notes 7 & 9)	D			
Thermal Resistance, Junction to Ambient	(Notes 8 & 9)	$R_{\theta JA}$			
	(Notes 8 & 10)				
Thermal Resistance, Junction to Lead (Notes 9 & 11)		$R_{ heta JL}$	17.1		
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150		°C	

Notes:

- 6. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector pads connected to each half.
- 7. Same as note (6), except the device is measured at t <5 sec.

 8. Same as note (6), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper.

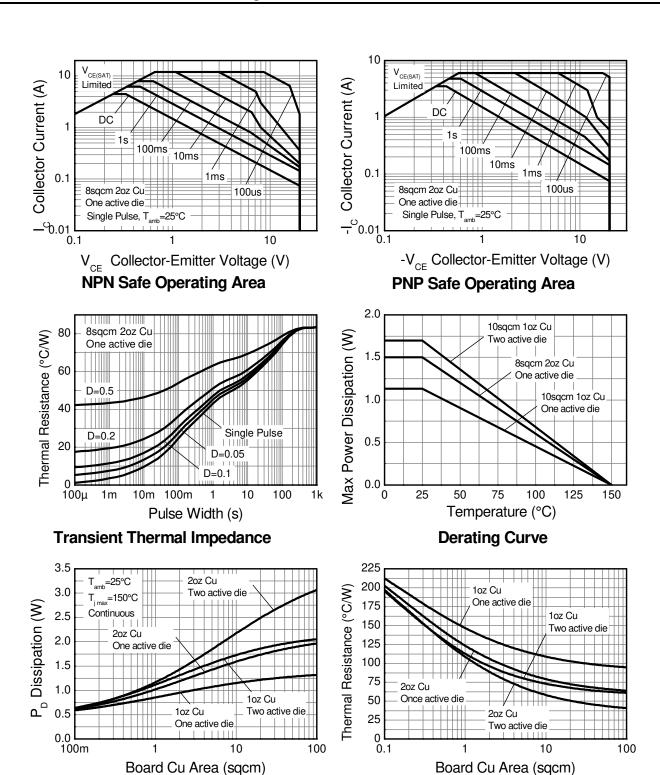
 9. For a dual device with one active die.

 10. For dual device with 2 active die running at equal power.

- 11. Thermal resistance from junction to solder-point (on the exposed collector pads).



Thermal Characteristics and Derating Information



Thermal Resistance v Board Area





NPN - Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

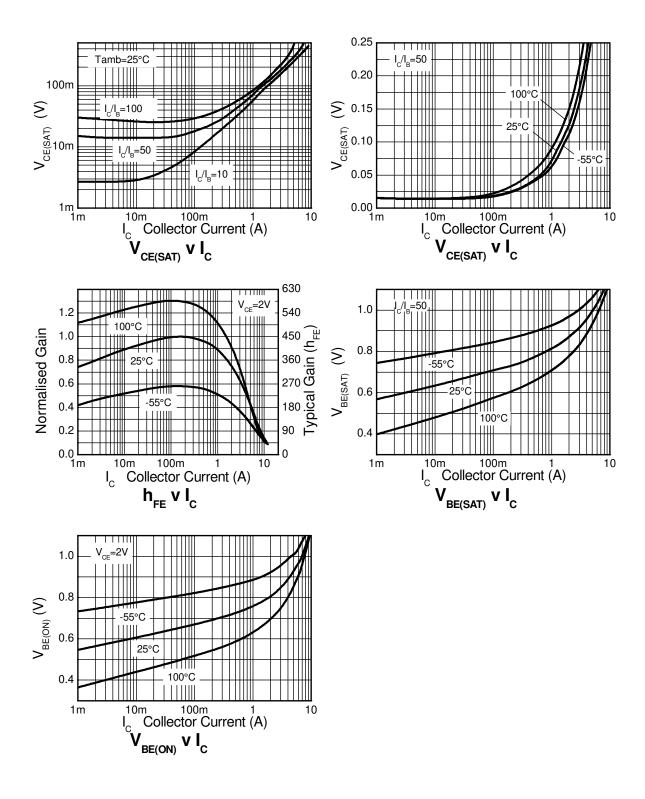
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_CBO	40	100	-	V	$I_C = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 12)	BV _{CEO}	20	27	-	V	$I_C = 10mA$
Emitter-Base Breakdown Voltage	BV_EBO	7	8.2	-	V	$I_E = 100\mu A$
Collector Cutoff Current	I _{CBO}	-	-	100	nA	$V_{CB} = 30V$
Emitter Cutoff Current	I _{EBO}	-	-	100	. nA	V _{EB} = 6V
Collector Emitter Cutoff Current	I _{CES}	-	-	100	nA	V _{CE} = 16V
Static Forward Current Transfer Ratio (Note 12)	h _{FE}	200 300 200 100	400 450 360 180	- - -	- - -	$\begin{split} &I_{C} = 10\text{mA}, \ V_{CE} = 2V \\ &I_{C} = 200\text{mA}, \ V_{CE} = 2V \\ &I_{C} = 2A, \ V_{CE} = 2V \\ &I_{C} = 6A, \ V_{CE} = 2V \end{split}$
Collector-Emitter Saturation Voltage (Note 12)	V _{CE(sat)}	-	8 90 115 190 210	15 150 135 250 300	mV	$I_C = 0.1A$, $I_B = 10mA$ $I_C = 1A$, $I_B = 10mA$ $I_C = 2A$, $I_B = 50mA$ $I_C = 3A$, $I_B = 100mA$ $I_C = 4.5A$, $I_B = 125mA$
Base-Emitter Turn-On Voltage (Note 12)	V _{BE(on)}	-	0.88	0.97	V	I _C = 4.5A, V _{CE} = 2V
Base-Emitter Saturation Voltage (Note 12)	V _{BE(sat)}	-	0.98	1.07	V	I _C = 4.5A, I _B = 125mA
Output Capacitance	C_obo	-	23	30	pF	V _{CB} = 10V, f = 1MHz
Transition Frequency	f _T	100	140	-	MHz	$V_{CE} = 10V, I_{C} = 50mA,$ f = 100MHz
Turn-on Time	t _{on}	-	170	-	ns	V _{CC} = 10V, I _C = 3A
Turn-off Time	t _{off}	-	400	-	ns	$I_{B1} = I_{B2} = 10 \text{mA}$

Notes: 12. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.





NPN - Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)







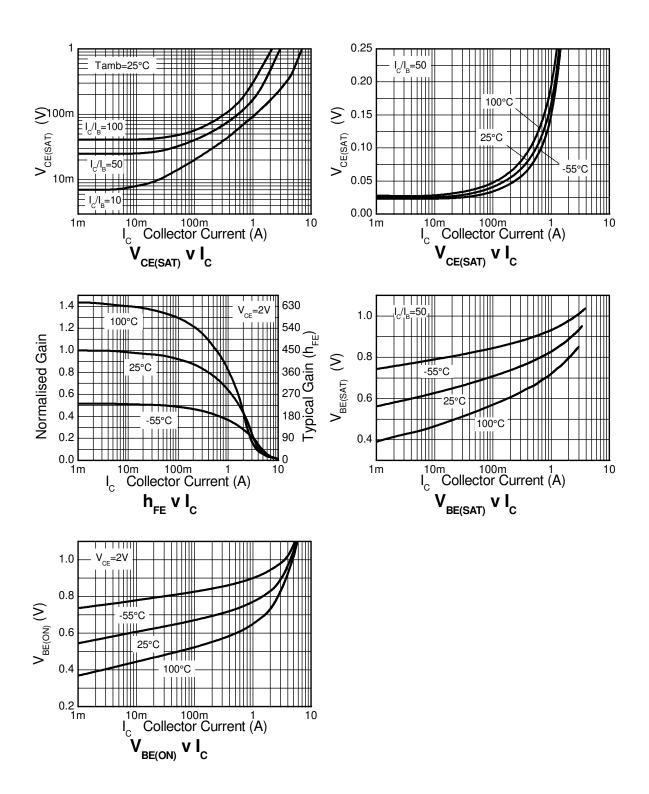
PNP - Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_CBO	-25	-35	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 12)	BV _{CEO}	-20	-25	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.5	-	V	$I_E = -100 \mu A$
Collector Cutoff Current	I _{CBO}	-	-	-100	nA	V _{CB} = -20V
Emitter Cutoff Current	I _{EBO}	-	-	-100	. nA	$V_{EB} = -6V$
Collector Emitter Cutoff Current	I _{CES}	-	-	-100	nA	V _{CES} = -16V
Static Forward Current Transfer Ratio (Note 12)	hFE	300 300 150 15	475 450 230 30	- - -	-	$I_{C} = -10$ mA, $V_{CE} = -2V$ $I_{C} = -100$ mA, $V_{CE} = -2V$ $I_{C} = -2$ A, $V_{CE} = -2V$ $I_{C} = -6$ A, $V_{CE} = -2V$
Collector-Emitter Saturation Voltage (Note 12)	V _{CE(sat)}		-19 -170 -190 -240 -225	-30 -220 -250 -350 -300	mV	$\begin{split} &I_{C} = -0.1A,\ I_{B} = -10\text{mA} \\ &I_{C} = -1A,\ I_{B} = -20\text{mA} \\ &I_{C} = -1.5A,\ I_{B} = -50\text{mA} \\ &I_{C} = -2.5A,\ I_{B} = -150\text{mA} \\ &I_{C} = -3.5A,\ I_{B} = -350\text{mA} \end{split}$
Base-Emitter Turn-On Voltage (Note 12)	V _{BE(on)}	-	-0.87	-0.95	V	I _C = -3.5A, V _{CE} = -2V
Base-Emitter Saturation Voltage (Note 12)	$V_{BE(sat)}$	-	-1.01	-1.12	V	$I_C = -3.5A$, $I_B = -350mA$
Output Capacitance	C_obo	-	21	30	pF	V _{CB} = -10V. f = 1MHz
Transition Frequency	f _T	150	180	-	MHz	$V_{CE} = -10V$, $I_{C} = -50mA$, $f = 100MHz$
Turn-on Time	t _{on}	-	40	-	ns	$V_{CC} = -10V, I_{C} = -1A$
Turn-off Time	t _{off}	-	670	-	ns	$I_{B1} = I_{B2} = -10 \text{mA}$

Notes: 12. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



PNP - Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

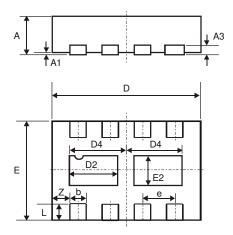






Package Outline Dimensions

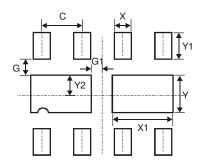
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



W-DFN3020-8							
	Type B						
Dim	Min	Max	Тур				
Α	0.77	0.83	0.80				
A 1	0	0.05	0.02				
А3	-	-	0.15				
b	0.25	0.35	0.30				
D	2.95	3.075	3.00				
D2	0.82	1.02	0.92				
D4	1.01	1.21	1.11				
е	1	-	0.65				
Е	1.95	2.075	2.00				
E2	0.43	0.63	0.53				
L	0.25	0.35	0.30				
Z	-	-	0.375				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
G	0.285
G1	0.090
Х	0.400
X1	1.120
Υ	0.730
Y1	0.500
Y2	0.365





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